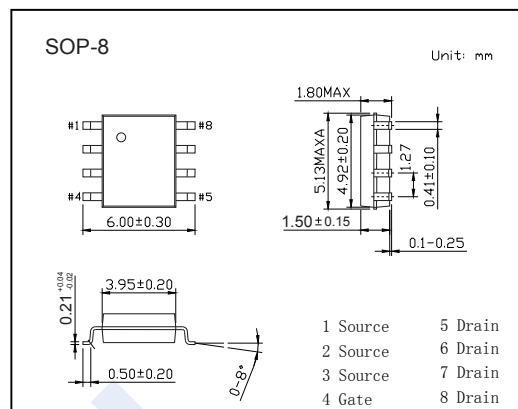
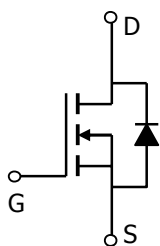


N-Channel MOSFET

AO4418 (KO4418)

■ Features

- $V_{DS} (V) = 30V$
- $I_D = 11.5 A$ ($V_{GS} = 20V$)
- $R_{DS(ON)} < 14m\Omega$ ($V_{GS} = 20$)
- $R_{DS(ON)} < 17m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 40m\Omega$ ($V_{GS} = 4.5V$)

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 25	
Continuous Drain Current	$T_A = 25^\circ C$	I_D	11.5	A
	$T_A = 70^\circ C$		9.7	
Pulsed Drain Current		I_{DM}	40	
Power Dissipation	$T_A = 25^\circ C$	P_D	3	W
	$T_A = 70^\circ C$		2.1	
Thermal Resistance.Junction- to-Ambient	$t \leq 10s$	R_{thJA}	40	$^\circ C/W$
	Steady-State		75	
Thermal Resistance.Junction- to-Lead		R_{thJL}	24	
Junction Temperature		T_J	150	$^\circ C$
Storage Temperature Range		T_{stg}	-55 to 150	

N-Channel MOSFET

AO4418 (KO4418)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μA, V _{GS} =0V	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V			1	μA
		V _{DS} =24V, V _{GS} =0V, T _J =55°C			5	
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±25V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250 μA	1.5		3	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =20V, I _D =11.5A			14	mΩ
		V _{GS} =20V, I _D =11.5A, T _J =125°C			18	
		V _{GS} =10V, I _D =10A			17	
		V _{GS} =4.5V, I _D =5A			40	
On State Drain Current	I _{D(on)}	V _{GS} =10V, V _{DS} =5V	40			A
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =10A	14	22		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =15V, f=1MHz		758		pF
Output Capacitance	C _{oss}			180		
Reverse Transfer Capacitance	C _{rss}			0.7		
Gate Resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.7		Ω
Total Gate Charge (10V)	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =11.5A		16.6		nC
Total Gate Charge (4.5V)				8.6		
Gate Source Charge	Q _{gs}			2.5		
Gate Drain Charge	Q _{gd}			4.9		
Turn-On DelayTime	t _{d(on)}	V _{GS} =10V, V _{DS} =15V, R _L =1.3Ω, R _{GEN} =3Ω		5.4		ns
Turn-On Rise Time	t _r			5.1		
Turn-Off DelayTime	t _{d(off)}			14.4		
Turn-Off Fall Time	t _f			3.7		
Body Diode Reverse Recovery Time	t _{rr}	I _F =11.5A, dI/dt=100A/μs		16.9		nC
Body Diode Reverse Recovery Charge	Q _{rr}			6.6		
Maximum Body-Diode Continuous Current	I _S				4.3	A
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V			1	V

Note : The static characteristics in Figures 1 to 6 are obtained using <300 us pulses, duty cycle 0.5% max.

■ Marking

Marking	4418 KC****
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N-Channel MOSFET

AO4418 (KO4418)

■ Typical Characteristics

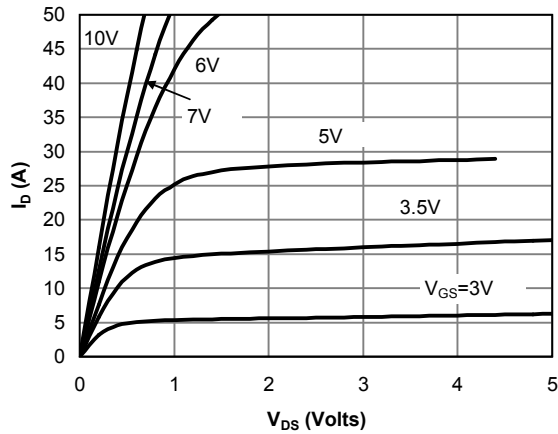


Fig 1: On-Region Characteristics

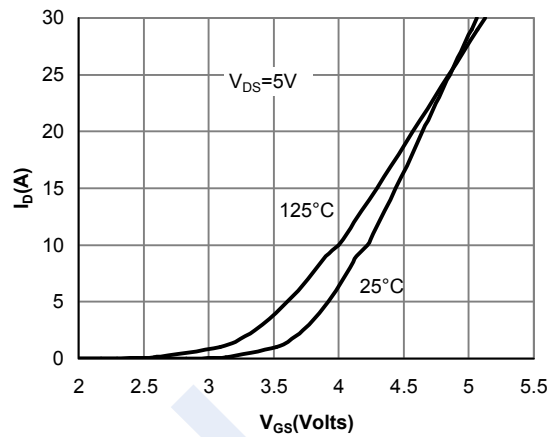


Figure 2: Transfer Characteristics

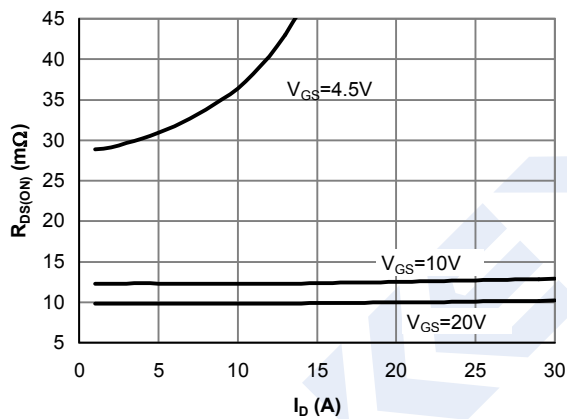


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

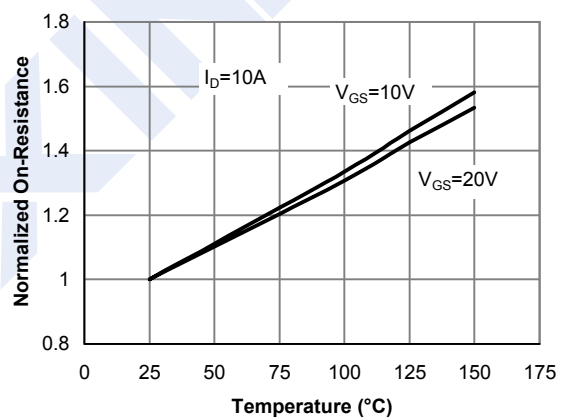


Figure 4: On-Resistance vs. Junction Temperature

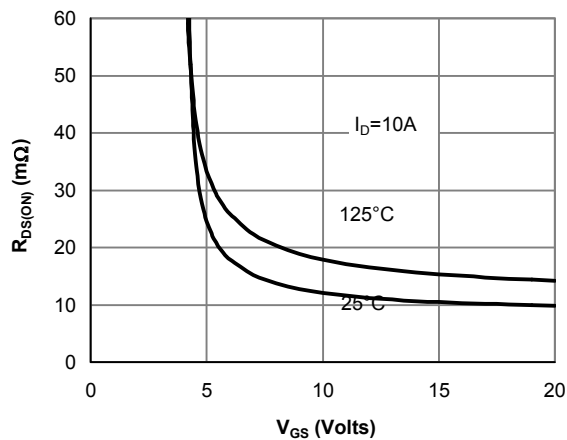


Figure 5: On-Resistance vs. Gate-Source Voltage

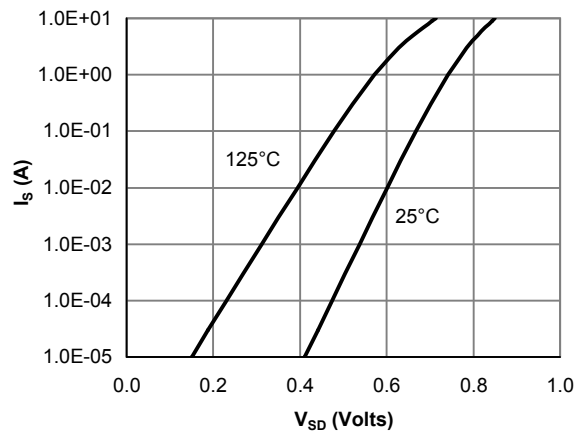


Figure 6: Body-Diode Characteristics

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■ Typical Characteristics

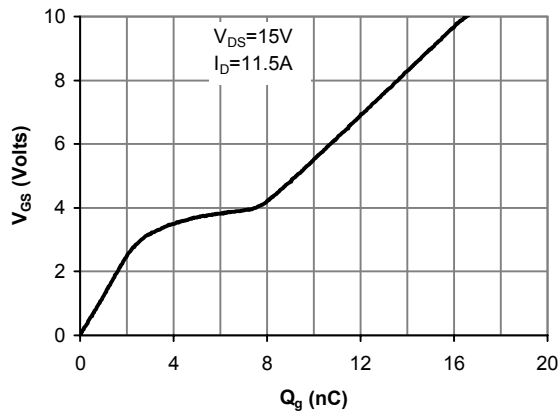


Figure 7: Gate-Charge Characteristics

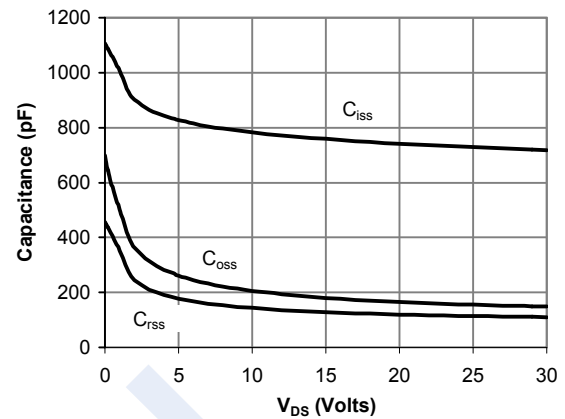


Figure 8: Capacitance Characteristics

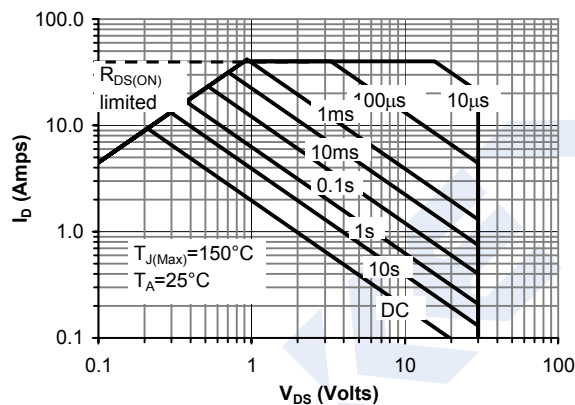


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

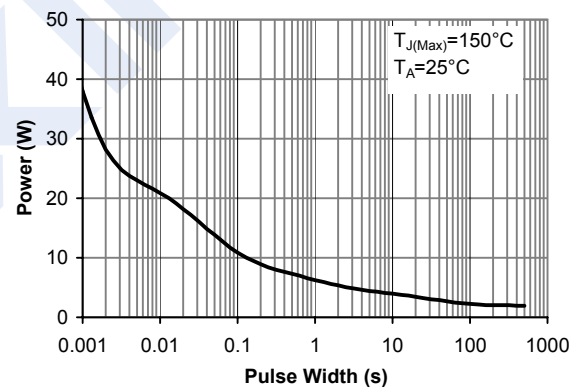


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

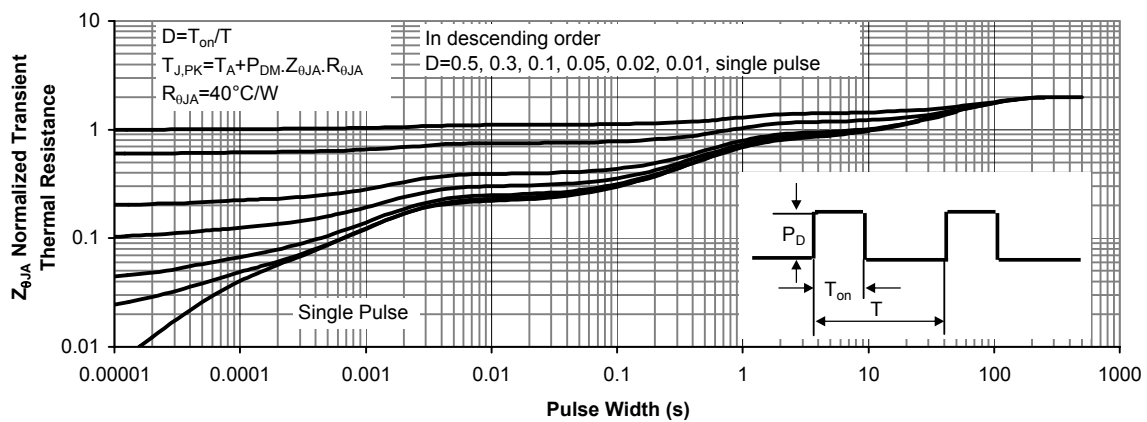


Figure 11: Normalized Maximum Transient Thermal Impedance